

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention

BOILING TEMPERATURE DESIGN IN PUMPED
MICROCHANNEL COOLING LOOPS

Application Number : 10/643638



Confirmation Number: 4432

First Named Applicant: Peng Zhou

Attorney Docket Number:

Art Unit:

Examiner:

Search string: (3361195 or 3771219 or 4644385 or 4893174 or 5386143 or 5658831 or 5675473 or 6140860 or 6477045 or 6492200 or 6578626).pn

Certification: This Information Disclosure Statement was submitted under the following conditions, which satisfies the requirement under 37 CFR 1.97(e). The filer certified:

That no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of the information disclosure statement.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	3361195	1968-01-02	A. Meyerhoff et al.			
	2	3771219	1973-11-13	Tuzi et al.			
	3	4644385	1987-02-17	Nakanishi et al.			
	4	4893174	1990-01-09	Yamada et al.			
	5	5386143	1995-01-31	Fitch			
	6	5658831	1997-08-19	Layton et al.			
	7	5675473	1997-10-07	McDunn et al.			
	8	6140860	2000-10-31	Sandhu et al.			
	9	6477045	2002-11-05	Wang	B1		
	10	6492200	2002-12-10	Park et al.	B1		
	11	6578626	2003-06-17	Calaman et al.	B1		

Signature

Examiner Name	Date